



2729GN-300V/VP

300 Watts ● 50 Volts ● 100 µs, 11% 2700 - 2900 MHz ● S-Band Radar

GENERAL DESCRIPTION

The 2729GN-300V is an internally matched, COMMON SOURCE, class AB, GaN on SiC HEMT transistor. The 2729GN-300VP is a 50 Ohms Input and Output matched pallet product on which is used the 2729GN-300V transistor. Both the transistor and pallet products provide over 14.5 dB gain, 300 Watts of pulsed RF output power at 100uS pulse width, 11% duty cycle across the 2700 MHz to 2900 MHz band. The hermetically sealed 2729GN-300V transistor is designed for S-band pulsed surveillance radar applications and uses all gold transistor metallization to provide highest reliability and superior ruggedness. The pallet construction employs best manufacturing practices construction resulting in highest quality and reliability while delivering and lowest overall manufactured systems costs.

Market Applications: S-Band Primary Pulsed Surveillance Radar Systems

ABSOLUTE MAXIMUM RATINGS

Maximum Power DissipationDevice Dissipation @ 25°C740 WMaximum Voltage and CurrentDrain-Source Voltage (VDSS)125 VGate-Source Voltage (VGS)-8 to +0 V

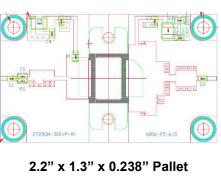
Maximum Temperatures

Storage Temperature (T_{STG}) -55 to +125° C Operating Junction Temperature +250 °C



CASE OUTLINE 55-QP

Common Source



ELECTRICAL CHARACTERISTICS @ 25°C

Symbol	Characteristics	Characteristics Test Conditions		Тур	Max	Units
Ρουτ	Output Power	P _{IN} = 10W, Freq=2700, 2900 MHz	300	335		W
GP	Power Gain	P _{IN} = 10W, Freq=2700, 2900 MHz	14.5	15.3		dB
ηD	Drain Efficiency	P _{IN} = 10W, Freq=2700, 2900 MHz	50	58		%
Dr	Droop	P _{IN} = 10W, Freq=2700, 2900 MHz		0.2	0.50	dB
θıc	Thermal Resistance	Pulse Width=100uS, Duty=11%			0.37	°C/W

• Bias Condition: Vdd=+50V, Idq=75mA constant current (Vgs= -2.0 ~ -4.5V typical)

FUNCTIONAL CHARACTERISTICS @ 25°C

I _{D(Off)}	Drain leakage current	V _{gS} = -8V, V _D = 125V		48	mA
$I_{G(Off)}$	Gate leakage current	$V_{gS} = -8V, V_{D} = 0V$		8	mA

Specifications are subject to change. For the most current information and sales contacts consult: www.MICROSEMI.com

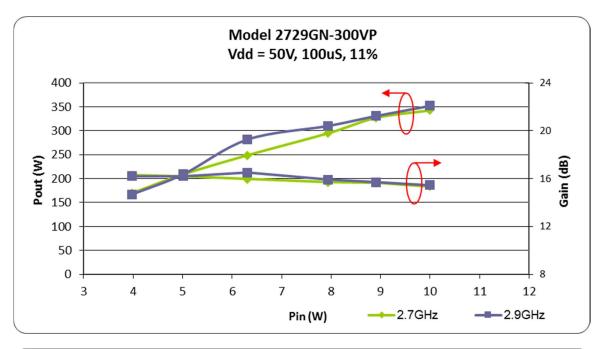


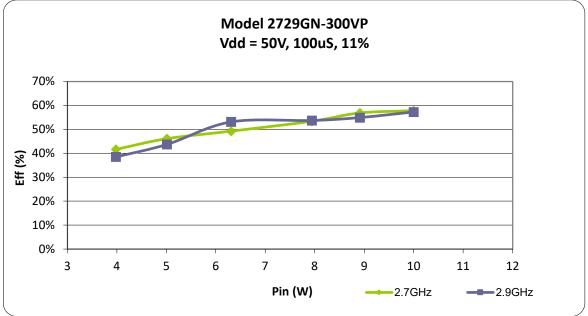
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TYPICAL BROAD BAND PERFORMACE DATA							
Frequency	Pin (W)	Pout (W)	ld (A)	RL (dB)	Nd (%)	G (dB)	Droop (dB)
2700 MHz	10	333	1.82	-13.0	57	15.2	.10
2900 MHz	10	378	1.90	-16.0	62	15.8	.15





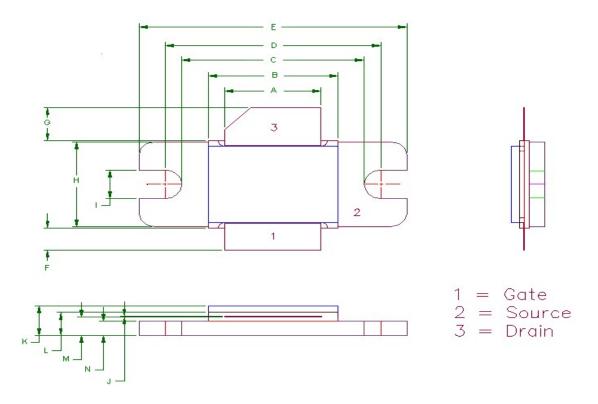
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55-QP PACKAGE DIMENSION



Dimension	Min (mil)	Min (mm)	Max (mil)	Max (mm)
Α	370	9.40	372	9.44
В	498	12.65	500	12.7
С	700	17.78	702	17.83
D	830	21.08	832	21.13
E	1030	26.16	1032	26.21
F	101	2.56	102	2.59
G	151	3.84	152	3.86
н	385	9.78	387	9.83
	130	3.30	132	3.35
J	003	.076	004	0.10
K	135	3.43	137	3.48
L	105	2.67	107	2.72
Μ	085	2.16	86	2.18
N	065	1.65	66	1.68



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R0.010 -R0.0985 R0.059 -SCREW HOLE RADIUS 0.136 C6 0.136 00 8 1.30 0.65 2729GN-300VP-R1 6006-25-6.15 1.10 R0.128 -SPRING DUTSIDE RADIUS 0.238 2.20 0.238 0.209

2729GN-300VP PALLET DIMENSIONS



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Revision History

Revision Level / Date	Para. Affected	Description
0.1 / 31 July 2019	-	Initial Preliminary Release